T2035H Series

Snubberless[™] high temperature 20 A Triacs

Main features

Symbol	Value	Unit
I _{T(RMS)}	20	A
V _{DRM} /V _{RRM}	600	1.02 V
I _{GT (Q1)}	35	mA
T _{j MAX}	150	°C

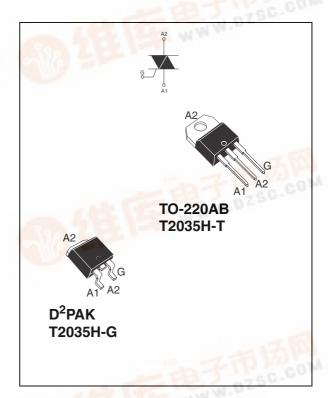
Description

Specifically designed to operate at 150° C, the new 20 A T2035H Triacs provide an enhanced performance in terms of power loss and thermal dissipation. This facilitates the optimization of heatsink dimensioning, leading to improved space and cost effectiveness when compared to electromechanical solutions.

Based on ST Snubberless[™] technology, the T2035H series offers high commutation switching capabilities and high noise immunity levels on the full range of T_j.

The T2035H series facilitates the optimization of the control of universal motors and inductive loads found in appliances such as vacuum cleaners, and washing machines.

The T2035H Triacs are also suitable for use in high temperature environment found in hot appliances such as cookers, ovens, hobs, electric heaters, and coffee machines.



Order code

Part number	Marking
T2035H-600G	T2035H-600G
T2035H-600G-TR	T2035H-600G
T2035H-600TRG	T2035H-600T

TM: Snubberless is a trademark of STMicroelectronics



1 Characteristics

Symbol	Parameter		Value	Unit	
I _{T(RMS)}	RMS on-state current (full sine wave)		T _c = 127° C	20	А
	Non repetitive surge peak on-state current	F = 60 Hz	t = 16.7 ms	210	А
ITSM	(full cycle sine wave, T_j initial = 25° C)	F = 50 Hz	t = 20 ms	200	A
l²t	I ² t Value for fusing tp = 10		0 ms	283	A ² s
dl/dt	Critical rate of rise of on-state current $I_G = 2xI_{GT}$, tr ≤ 100 ns $F = 120$ Hz		T _j = 125° C	50	A/µs
V _{DSM} /V _{RSM}	Non repetitive surge peak off state voltage		T _j = 25° C	700	V
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 150° C	4	А
P _{G(AV)}	Average gate power dissipation $T_j = 150^{\circ} C$				W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			-40 to +150 -30 to +150	°C
Τ _Ι	Maximum leads soldering temperature during 10 s				°C

Table 1. Absolute maximum ratings

Table 2.Electrical characteristics ($T_j = 25^\circ C$, unless otherwise specified)

Symbol	Test conditions Quadrant			Value	Unit
I _{GT} ⁽¹⁾	V _D = 12 V, R _I = 33 Ω	- -	MAX	35	mA
V _{GT}	$v_{\rm D} = 12$ v, $n_{\rm L} = 33.32$	- -	MAX	1.3	V
V _{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega, T_j = 150^{\circ} \text{ C}$	- -	MIN	0.15	V
I _H ⁽²⁾	I _T = 100 mA		MAX	35	mA
١L	$I_{G} = 1.2 \text{ x } I_{GT}$	1 - 111	мах	50	mA
1		II	MAA	80	
dV/dt ⁽²⁾	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150^{\circ} C$			300	V/µs
(dl/dt)c ⁽²⁾	Without snubber, $T_j = 150^{\circ} \text{ C}$		MIN	8.9	A/ms

1. minimum I_{GT} is guaranteed at 5% of I_{GT} max

2. for both polarities of A2 referenced to A1

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Characteristics

Symbol	Test condition	Value	Unit		
V _{TM} ⁽¹⁾	I _{TM} = 28 A, t _p = 380 μs	Tj = 25° C	MAX	1.5	V
V _{TO} ⁽¹⁾		Tj = 150° C	MAX	0.80	V
R _D ⁽¹⁾		Tj = 150° C	MAX	21	mΩ
	<u> </u>	Tj = 25° C		5	μΑ
I _{DRM} I _{RRM}	$V_{DRM} = V_{RRM}$	Tj = 150° C	MAX	7.4	mA
'RRM	$V_D/V_R = 400 V$ (at peak mains voltage)	Tj = 150° C		4.8	ША

Table 3. Static electrical characteristics

1. for both polarities of A2 referenced to A1

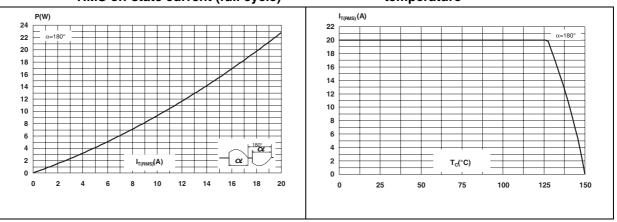
Table 4. Thermal resistance

Symbol	Parameter				Unit
R _{th (j-c)}	Junction to case for full (AC)		D ² PAK TO-220AB	1	
P	Junction to ambient	S = 1 cm ²	D ² PAK	45	°C/W
R _{th (j-a)}			TO-220AB	60	

Figure 1. Maximum power dissipation vs RMS on-state current (full cycle)

Figure 2. RMS on-

RMS on-state current versus case temperature



Characteristics

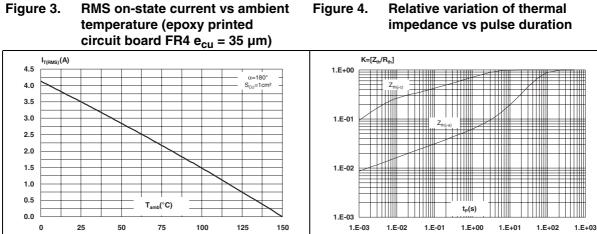
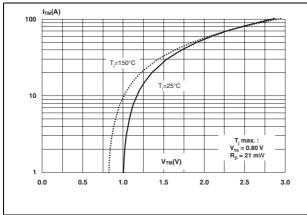


Figure 5. **On-state characteristics** (maximum values)



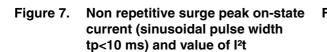


Figure 6. Surge peak on-state current vs number of cycles

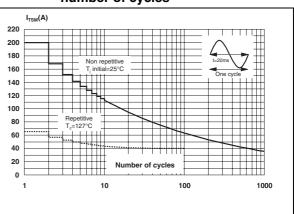


Figure 8. Relative variation of gate trigger current, holding current and latching current vs junction temperature (typical values)

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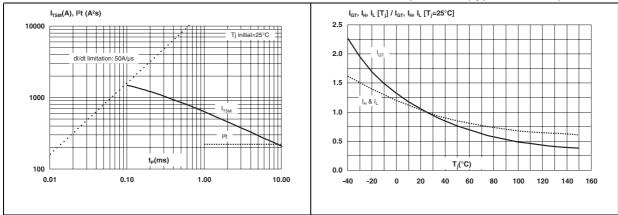


Figure 9. Relative variation of critical rate of Figu decrease of main current (di/dt)c vs reapplied (dV/dt)c

Figure 10. Relative variation of critical rate of decrease of main current (di/dt)c versus junction temperature

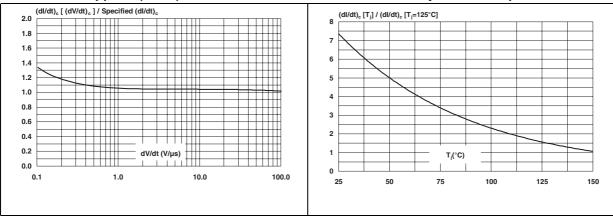
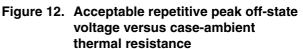


Figure 11. Leakage current versus junction temperature for different values of blocking voltage (typical values)



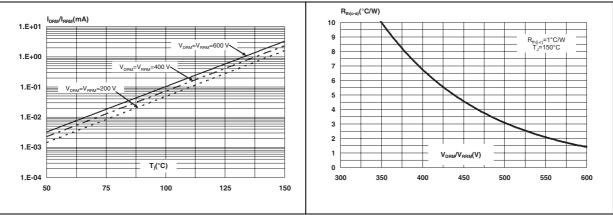
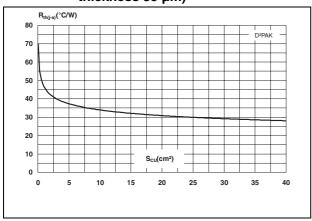


Figure 13. D²PAK junction to ambient thermal resistance versus copper surface under tab (PCB FR4, copper thickness 35 µm)





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Ordering information scheme

			T (-TR) │
Triac series			
Current			
20 = 20 A			
Sensitivity			
35 = 35 mA			
High temperature			
Voltage			
600 = 600 V			
Package			
$G = D^2 PAK$			
T = TO-220AB			
Packing mode			
Blank = Tube (D^2PAK)			
-TR = Tape and reel (D2PAK)			
RG = Tube (TO-220AB)			

3 Package information

Table 5.	10-220AB d	imensions							
						DIMEN	SIONS		
			REF.	Mi	illimete	rs		Inches	
				Min.	Тур.	Max.	Min.	Тур.	Max.
			А	15.20		15.90	0.598		0.625
	В	с	a1		3.75			0.147	
-	ØI	b2	a2	13.00		14.00	0.511		0.551
/			В	10.00		10.40	0.393		0.409
		·····	b1	0.61		0.88	0.024		0.034
14	A		b2	1.23		1.32	0.048		0.051
II I3	<u></u>		С	4.40		4.60	0.173		0.181
	a1 ↓		c1	0.49		0.70	0.019		0.027
12	12 a2		c2	2.40		2.72	0.094		0.107
			е	2.40		2.70	0.094		0.106
	↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓	M ← c1	F	6.20		6.60	0.244		0.259
	e		ØI	3.75		3.85	0.147		0.151
			14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116	
			12	1.14		1.70	0.044		0.066
			13	1.14		1.70	0.044		0.066
			М		2.60			0.102	

Table 5. TO-220AB dimensions



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L

DIMENSIONS REF. Millimeters Inches Min. Min. Max. Max. А 4.40 4.60 0.173 0.181 A1 2.49 2.69 0.098 0.106 A2 0.03 0.23 0.001 0.009 В 0.70 0.93 0.027 0.037 D B2 1.14 1.70 0.045 0.067 С 0.45 0.60 0.017 0.024 C2 1.23 1.36 0.048 0.054 B2 8.95 9.35 0.352 0.368 D с R В Е 10.00 10.40 0.393 0.409 G 4.88 5.28 0.192 0.208 0.590 2mm min. L 15.00 15.85 0.624 FLAT ZONE L2 1.27 1.40 0.050 0.055 L3 1.40 1.75 0.055 0.069 2.40 3.20 0.094 0.126 Μ

R

V2

0.40 typ.

8°

0°

0.016 typ.

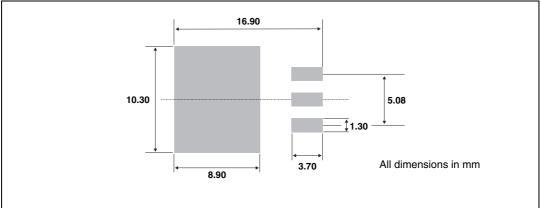
8°

57

0°







In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



4 Ordering information

Part number	Marking	Package	Weight	Base Qty	Packing mode
T2035H-600G	T2035H-600G	D ² PAK	1.5 g	50	Tube
T2035H-600G-TR	T2035H-600G	D ² PAK	1.5 g	1000	Tape and Reel
T2035H-600TRG	T2035H-600T	TO-220AB	2.3 g	50	Tube

5 Revision history

Date	Revision	Changes
13-Jul-2006	1	Initial release.



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